I hereby construction of the United States Posts Service as first class mail in an envelope as III are commissioner for Patents, Washington, D.C. 20231, on November 5, 2001 Date of Deposit Tadashi Horie Name of applicant, assignee or Registered Representative Signature November 5, 2001 Date of Signature

Our Case No. 10269/3

11/A 12/04/01 p. wllm

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Dear Sir:

In response the Office Action mailed July 9, 2001, please enter the following amendment and consider the following remarks:

IN THE CLAIMS:

IMS:
Please replace claim 1 with the following new claim 1 (APPENDIX 1): **(1)**

(once amended) A wafer conveyance system, comprising: 1. a plurality of wafer processing apparatuses each having an insertion portion; a guide path defined along said plurality of wafer processing apparatuses;

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